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ASIA SHANGHAI

24 – 26.9.2025

Shanghai New International
Expo Centre, China
中国 • 上海新国际博览中心



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PCIM Asia Shanghai – International Exhibition and
Conference for Power Electronics, Intelligent Motion,
Renewable Energy and Energy Management

电力电子、智能运动、可再生能源

上海国际电力元件、可再生能源管理展览会暨研讨会

After Show Report 2025

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电力电子、智能运动、可再生能源

上海国际电力元件、可再生能源管理展览会暨研讨会
PCIM Asia Shanghai – International Exhibition and
Conference for Power Electronics, Intelligent Motion,
Renewable Energy and Energy Management



>> Power Electronics >> Intelligent Motion >> Renewable Energy >> Energy Management

- Sister show of PCIM Expo & Conference, a leading international exhibition and conference for power electronics in Asia.
- Showcase the entire value chain ranging from power semiconductors, passive components, thermal management products, and new materials to sensors and servo-technology.
- Provide the solutions to industrial electronics, consumer electronics, e-mobility, extra power appliance, new energy (photovoltaic, wind energy), smart home and other fields.



Venue : Halls N4 & N5 , Shanghai New International Expo Centre (SNIEC) , China



Date : 24-26 September 2025



Organizer : Guangzhou Guangya Messe Frankfurt Co Ltd

Partner : Mesago Messe Frankfurt GmbH

Sponsors





At a Glance

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ASIA SHANGHAI



25,000

Exhibition Area (m²)

A 25% year-on-year growth



1,244

Conference Visits



16,971

Visits

From 50 countries and regions



95

Conference Presentations



265

Exhibitors

From 11 countries and regions

A 14% year-on-year growth



71

Forum Presentations



19

Delegations



3,043

Forum Visits





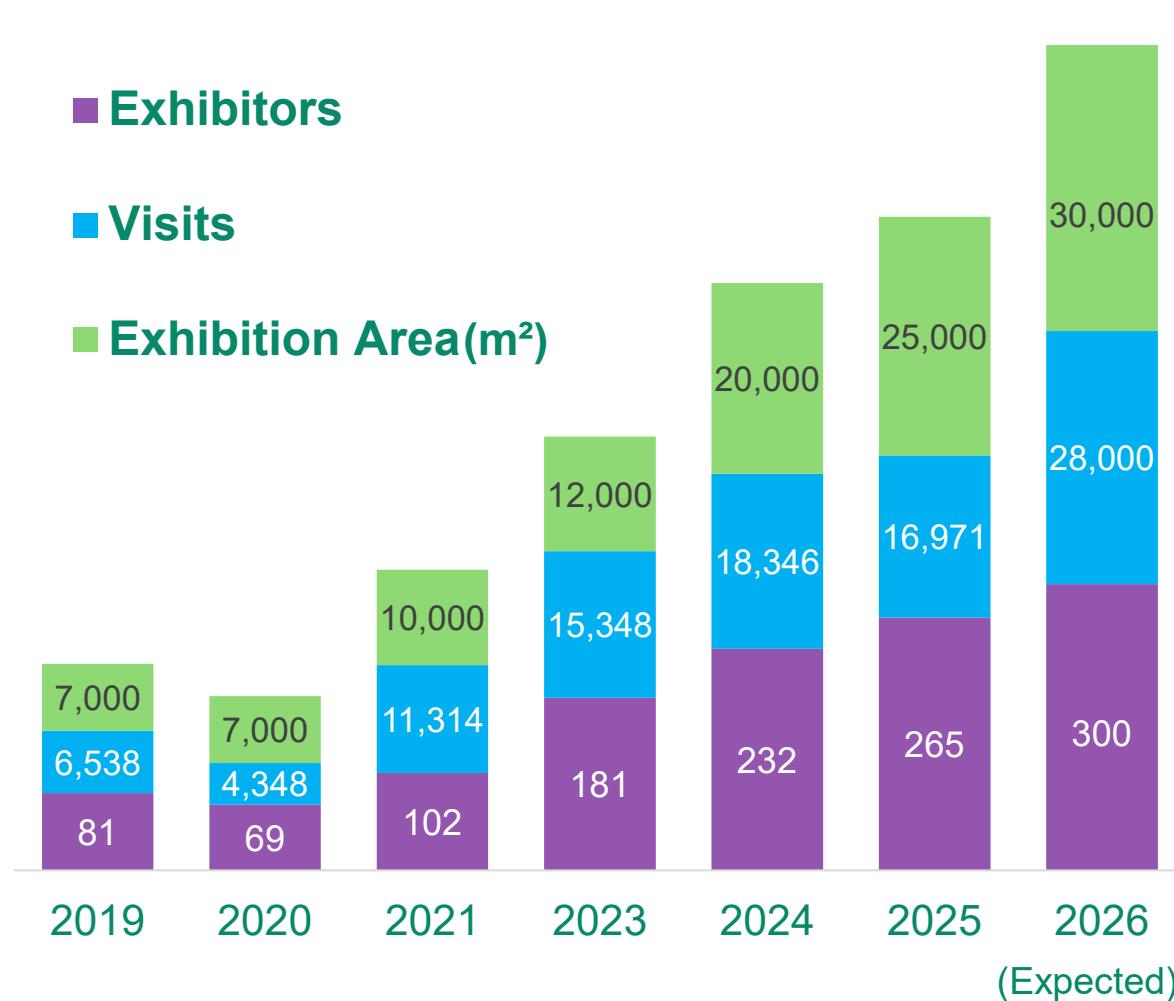
2019-2026 Data Analysis

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ASIA SHANGHAI



From 2019 to 2025, the exhibition demonstrated substantial growth across various fields:

- Exhibitor numbers increased by **227%**, covering the whole power electronics industry chain;
- Domestic and international visitors grew by **160%**, continuously enhancing PCIM Asia Shanghai influence and international recognition.
- Exhibition area expand by **257%**, significantly expanding in scale, and featured diversified concurrent events.





WeChat Ecosystem Marketing Data



30K

WeChat Official
Account Followers



220K+

WeChat Posts Views



454

WeChat Posts



280K+

Video Views



77

Video Posts



4.5Millions+

Email Deliveries



72

eDMs Campaigns



2Millions+

Pre-show Promotion SMS



39

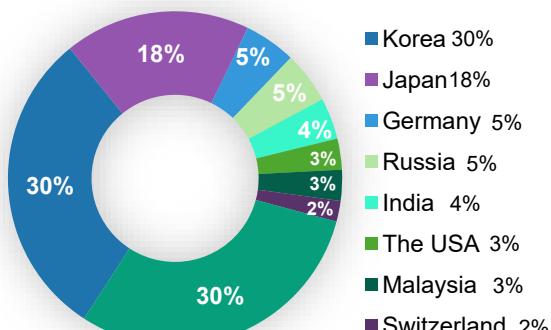
Media Partners

Visitors Data 01

Origin of The Visitors



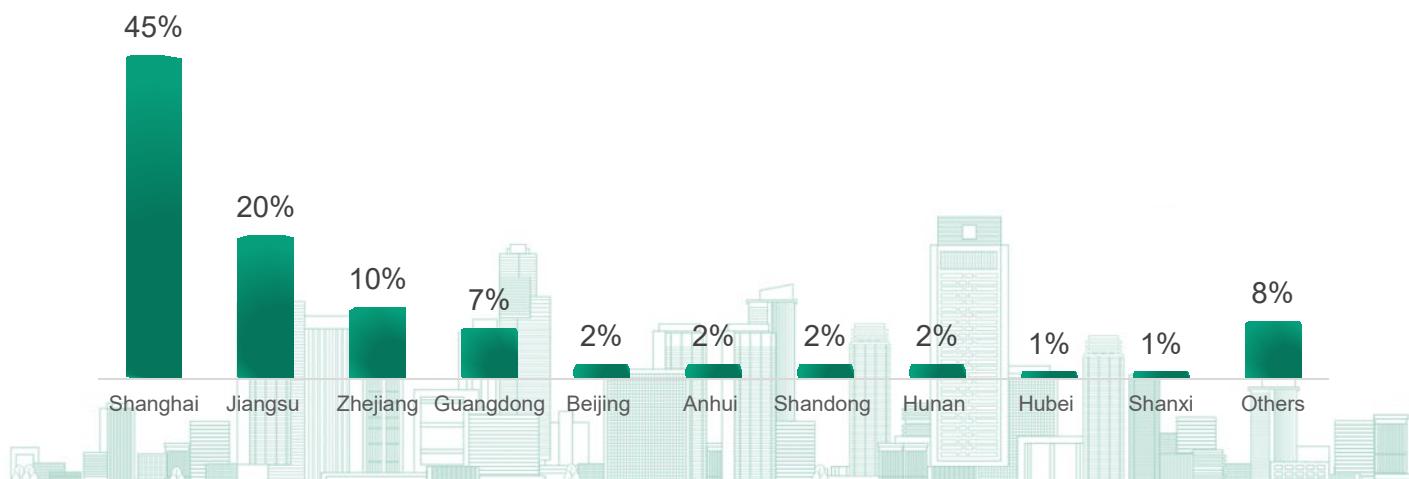
6%
International
Visitors



Other overseas countries and regions: 30% (Includes France, Lesotho, Cambodia, Egypt, Pakistan, South Africa, Vietnam, Austria, Brazil, Finland, Iran, Poland, Sweden, Afghanistan, Angola, Azerbaijan, Barbados, Belgium, Bolivia, Canada, Chile, Colombia, Guatemala, Hungary, Kosovo, Kyrgyzstan, Mexico, Oman, Paraguay, The Philippines, Portugal, Thailand, The UK, Yemen, Greece, Cape Verde, and Syria)

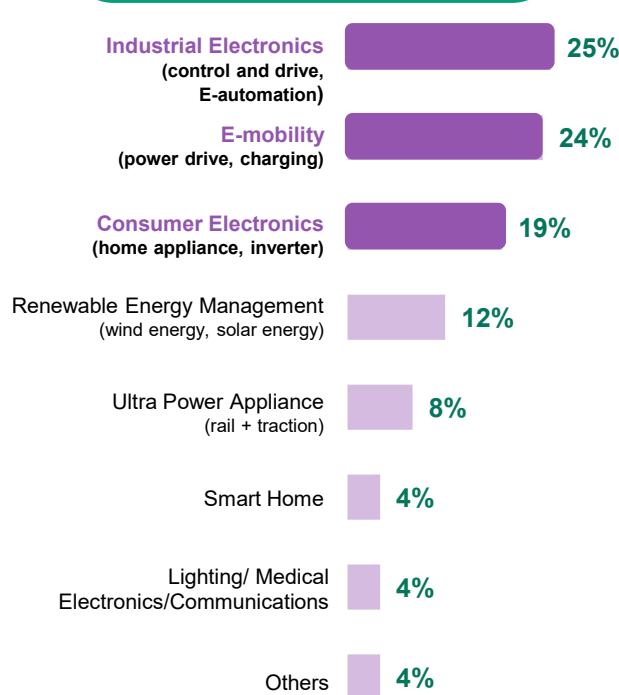
*Other Overseas Countries and Regions (sorted in descending order by viewer count.)

Distribution of Visitors by Province in China

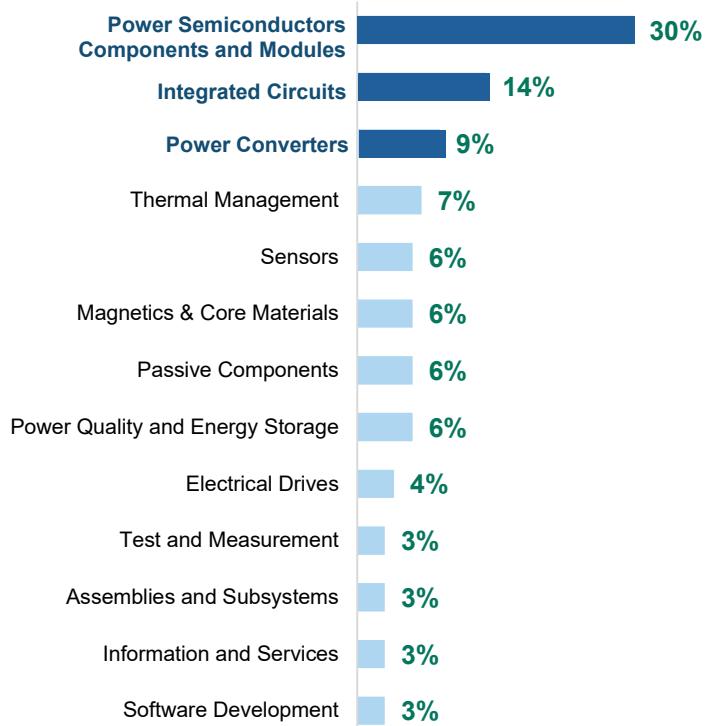


Visitors Data

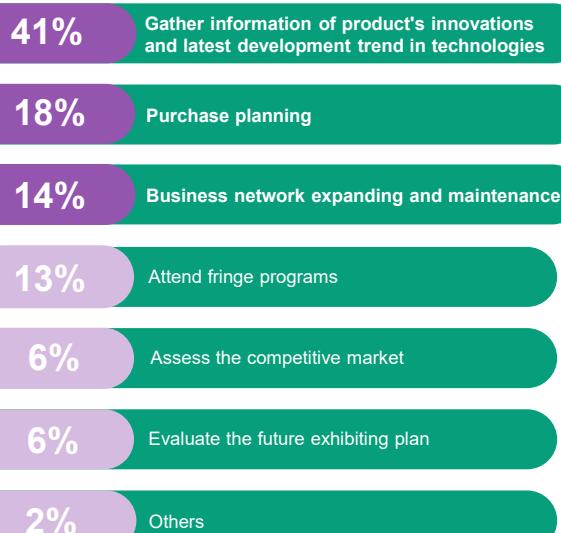
Industry of The Visitors



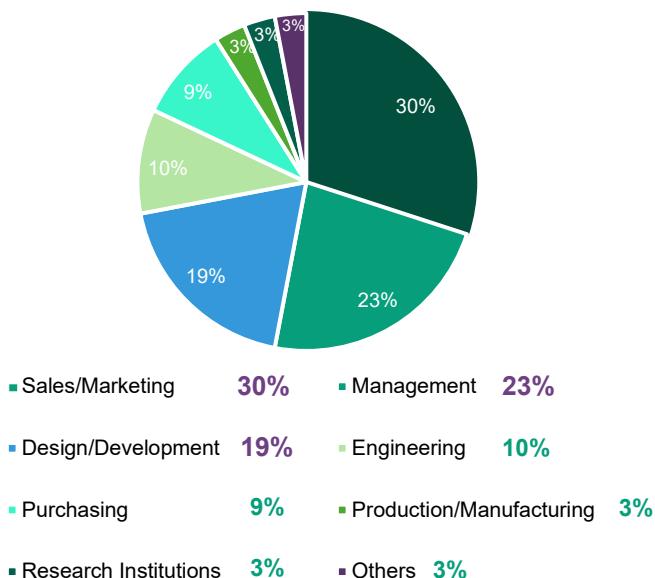
Products of Interest to Visitors



Visitors' Purchase – Information Collection and Purchase Planning



Position of The Visitors





Industrial Electronics

Sungrow Power Supply Co., Ltd.
Daxin Semiconductor Co., Ltd.
Wuxi Xinchang Electronic Co., Ltd.
Hoymiles Power Electronics Inc.
Changzhou Tonghui Electronic Co., Ltd.
S3parMicro Electronics (Suzhou) Co., Ltd.
Shanghai G-Pulse Electronics Technology Company Limited
Wuxi DK Electronic Materials Co., Ltd.
Nanjing Sunlord Electronics Corporation Ltd.

Shenzhen Mingyang Circuit Technology Co., Ltd.
Shanghai Shengwei Electronic Technology Co., Ltd.
Weimi Technology (Wuxi) Co., Ltd.
EcoFlow Inc.
Xiamen Xinyidai Integrated Circuit Co., Ltd.
Shanghai Huawei Digital Energy Technology Co., Ltd.
Suzhou Inovance Technology Co., Ltd.
Anhui Haiming Micro Semiconductor Co., Ltd.



New Energy

Dai Sheng Riyuan New Energy (Suzhou) Co., Ltd.
Weimi Technology (Wuxi) Co., Ltd.
Joyson New Energy Vehicle Technology Co., Ltd.
Shanghai Dianba New Energy Technology Co., Ltd.
Suzhou Bowo Chuangxin Energy Technology Co., Ltd.

Automotive Electronics



United Automotive Electronic Systems Co., Ltd. (UAES)
Weichai Power Co., Ltd.
Intelligent Electro Mobility R&D Center by TOYOTA (China) Co., Ltd. (IEM by TOYOTA)
NIO Co., Ltd.
Xiaomi Automobile Technology Co., Ltd.
Shanghai Lixiang Automotive Technology Co., Ltd.
Geely Automobile Research Institute (Ningbo) Co., Ltd.
Chongqing Changan Automobile Co., Ltd.
Hefei Junlian Automotive Electronics Co., Ltd.
Jaguar Land Rover (China) Investment Co., Ltd.
Renault (Beijing) Automobile Co., Ltd. Shanghai Branch



Consumer Electronics

GREE ELECTRIC APPLIANCES, INC. OF ZHUHAI
HISENSE HOME APPLIANCES GROUP CO., LTD.
PANASONIC INDUSTRY (CHINA) CO., LTD.
Haisi Technology Co., Ltd.
Shenzhen Transsion Holdings CO., LTD.
Tongfu Microelectronics Co., Ltd.

Tongxin Microelectronics Co., Ltd
BEAR ELECTRIC APPLIANCE CO., LTD.
DeKron Microelectronics (Shenzhen) Co., Ltd.
Shanghai Xinhui Electric Appliance Co., Ltd.



PCIM Asia Shanghai 2025 welcomes delegations from industries including consumer electronics, industrial electronics, medical equipment, home appliance, automobile and manufacturing.

2025 Delegations

Panasonic
松下电器

DELTA 台达

BOSCH

Garrett
ADVANCING MOTION

RENAULT

Weiking 伟京

恒力机床
THE MACHINE TOOL LTD.

Silicon Magic
芯迈半导体

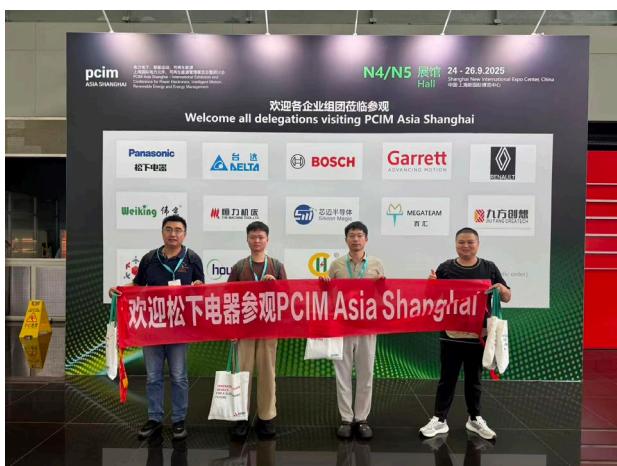
MEGATEAM
百汇

JIU FANG CREATECH

IMI

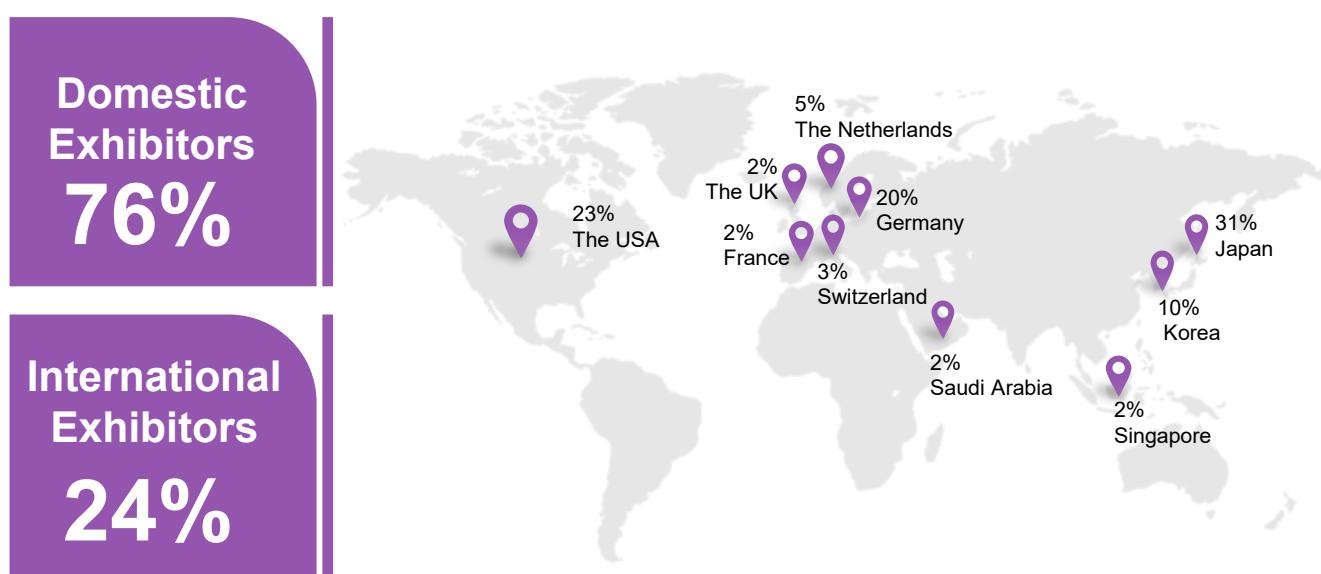
hoytmiles

华驰电气

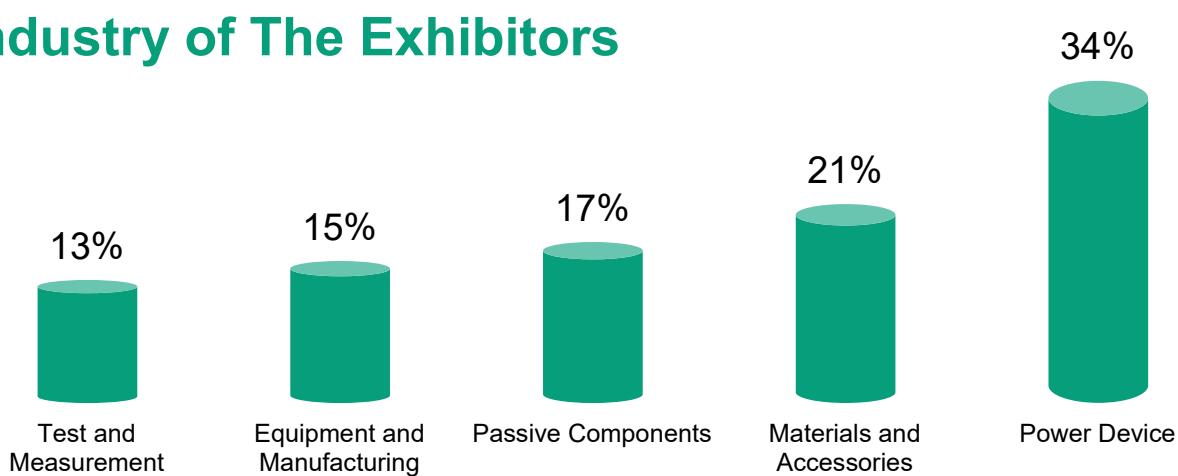


Exhibitors Data 02

Analysis of exhibitors from different countries and regions



Industry of The Exhibitors



PCIM Asia Shanghai 2025 Sponsors



PCIM Asia Shanghai 2025 Exhibitors

MITSUBISHI ELECTRIC	SEMIKRON DANFOSS	富士电机	Infineon	ROHM	nexperia	HITACHI	BOSCH	TOSHIBA	onsemi	BOURNS	molex	AVX	muRata	AVX
power integrations	TAIYO YUDEN	MinebeaMitsumi	VISHAY	IEPC	Melexis	NXO	NAGASE	ROGERS CORPORATION	Sabic	TE	IVCT	AVX	NARROWBAND	Intersil
Hisense	Heraeus	G	吉姆电子	SEMI-FUTURE	BYSV	ALKAID SEMI	ساتيك	KEYSIGHT	IVCT	IVCT	IVCT	AVX	SHINE	GaNext
ABB	macrocore	益千线	WINSPOWER	华友线材	方正印电子	HANTE	尚阳通	TELEFUNKEN	REDPOWER	谱香港	crosschip	UTC	恩沁基	AVX
BEMI SUSUMU	DOWA	Hivave	晶电	吉川电子	THERUCEN	华清电子材料	三井资源	CAJM	PRECIE	SECTECH	PRECIE	SHONGE	BI	GT
法拉电子	FROM	FR	AISEC	pico	微道	长川半导体	MECHATEK	RAYTRONIC	POWERTRIM	CONQUER	PRECIE	ESTEC	莱晶科技	上海林众电子
YIKEY	YMI	KOKI	San'an	Meorock	Gandonic	GTS	SOLDERWELL	SANZHU	DOU YEE	CuNex	PRECIE	EBG	LEORE	上海林众电子
振耀精工	CeramTec	KEW	INVENTEC	Nidec	HUSTEC	P4	QLSemi	XIAOTI	DKEM	TECHNOM	TECHNOM	ESTEC	安泰天龙	BEST SCALE
VICO	BOSON MATERIAL	SDI	HEX CERAM	Amulair	LED	奥拓	天域TYSIC	TESTRON	Tektronix	JIG	CERGEN	EBG	Mi Equipment	M
虹润	DRE	CRRC	宏微	卓微	Power Electronics	ATIS	东泰公司	SINDIN	TECHNOM	LEM	MIDI	M	PCB	PCB
津上精密	BOB	REB	Iwatani	BUICK	JIAYI	ATIS	纳泰公司	YUAN	TECHNOM	LEADER	COOLTECH	COOLTECH	江川	江川
LAM	Convert	Unisic	NP	HVT	ATIS	ATIS	纳泰公司	YUAN	TECHNOM	LEADER	COOLTECH	COOLTECH	JUFENG	JUFENG
金溢海通	TANAKA	东固宇能	W.B.S.D.	NANOTEST	瑞芯微	H2	Microphen	YUAN	TECHNOM	LEADER	COOLTECH	COOLTECH	KOTTLER	GARENSEMI
Myway	SCHAIN	IMC	PROTECH	IWATSU	ED-1	广广光通	CNSIM	K+SPARK	华泰电子	Mesio	昌硕	昌硕	CHMC	CHMC
SINOCERA	KunSemi	天合	PINK	华晶科	Kayo	DYNANO	舒泰科技	东固宇能	方洋	SCHLENK	ZDC	ZDC	BALZE	CII

* Not in specific order



► Exhibitors Comments



“Power Integrations provides power conversion devices for everything from phone adapters to renewable energy. Here at PCIM Asia Shanghai, we’re showcasing our SCALE-iDriver for railway applications and our automotive solutions. This year has been very productive, with many successful sales meetings and customer visits. The PCIM series is probably the best for our company when it comes to meeting with actual customers and getting business done. “

Ms Linda Williams, Director of Marketing Communications, Power Integrations



“As a major event for the power electronics industry, this platform brings together leading companies to present the latest in cutting-edge technology and innovation. For us, our focus this year is on achieving three key objectives: staying updated on industry trends, meeting face-to-face with our customers to find new market opportunities, and showcasing our own products and technology to build our brand's influence.”

Mr Hua Wang, Deputy Head, Power Semiconductor Device Group, Minebea Trading (Shanghai) Ltd



“Hisense Home Appliances is expanding into the upstream industry with our own power semiconductor division. After three years of development, our components are now in mass production in our own appliances, and we chose the renowned PCIM Asia Shanghai to officially introduce these components to the wider market. The results have been very positive; in just the first day and a half, we've held productive technical discussions, gathered new customer contacts and introduced our brand to the media.”

Ms Jenny Wu, Director of Sales Department, Power Semiconductor Development Division, Hisense Power Semiconductor



Conference Data 03

1,244

Conference Visits

95

Conference Presentations



3 Keynotes



1 Special Session

1. Technological Evolution and Future Perspectives of Electric Vehicle
2. Ultra-Compact and Efficient Power Supply Enabling AI Computing
3. Evolutionary Trends in Power Supply for AI Data Centers



9 Oral Sessions

1. WBG I SiC
2. WBG II GaN
3. Smart Grid Power Electronics
4. Si Device
5. Packaging & Reliability I
6. Packaging & Reliability II
7. Motor Drive & Motion Control
8. SiC related hybrid switch
9. Advanced low power Module Design

1. "Power Chiplet" technology, ultra-high-power density platform for future power electronics

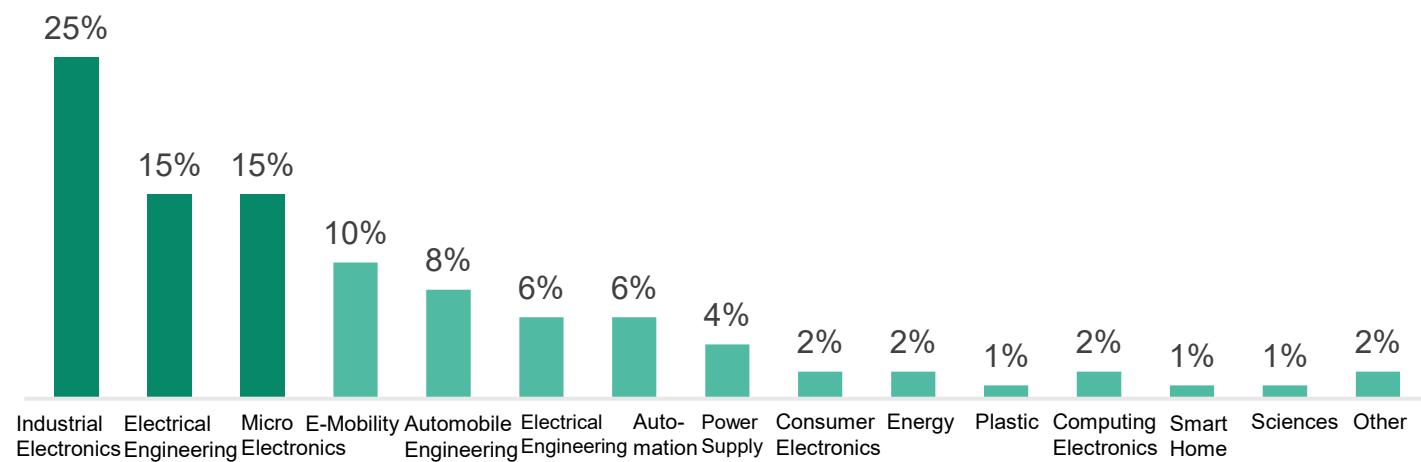


7 Poster Dialogue Sessions

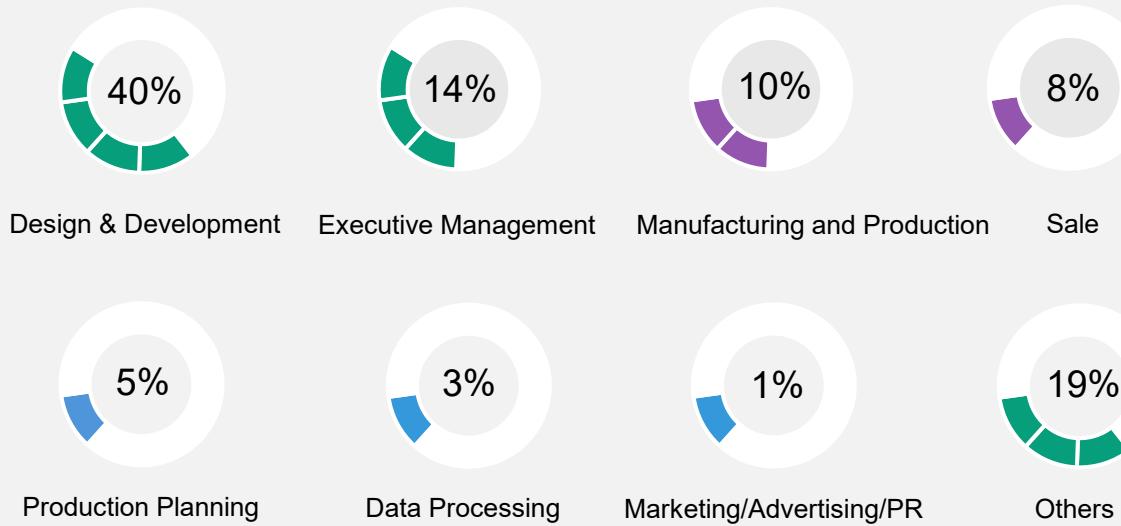
1. Power Si-Devices
2. WBG Devices
3. Packaging & Reliability
4. Power Converter
5. Motor Control
6. High Frequency Power Converter
7. Smart Grid & Energy Transmission

Conference Participants Analysis

Industry



Job Function



Award Winners 2025

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BEST PAPER AWARD WINNER



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Best Paper Award
WINNER

Sponsored by:



Research on Overcurrent Interruption Capability and Influencing Factors of SiC MOSFETs in DCCBs

Xiangyu Wan, Huazhong University of Science and Technology, China

YOUNG ENGINEER AWARD WINNER



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Young Engineer Award
WINNER

Sponsored by:



3D Wiring Technology Development for Power Modules to Achieve High-Power Density

Akito Nakagome, Fuji Electric Co., Ltd., Japan

UNIVERSITY SCIENTIST AWARD



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University Scientist Award
WINNER

Sponsored by:



英飞凌

- ◆ Wending Zhao, ZJU-Hangzhou Global Scientific and Technological Innovation Center, China
- ◆ Dan Zheng, State Key Laboratory of High Density Electromagnetic Power and Systems, Institute of Electrical Engineering, Chinese Academy of Sciences, China
- ◆ Jiahui He, Harbin Institute of Technology, China
- ◆ Jiaxuan Yu, Shanghai University, China
- ◆ Christos Mademlis, Aristotle University of Thessaloniki, Greece

EXCELLENT POSTER AWARD



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Excellent Poster Award
WINNER

- ◆ Bining Liu, Tongji University, China
- ◆ Chaojie Zhu, Shanghai University, China
- ◆ Xing Chen, Zhuzhou CRRC Times Semiconductor Co. Ltd., China

- ◆ Wenqi Zhou, Robert Bosch GmbH, Germany
- ◆ Ruiye Li, Harbin Institute of Technology, China
- ◆ Zhaoliang Wen, Harbin Institute of Technology, China

Speakers of PCIM Asia Shanghai Conference 2025



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Prof. Dr. Leo Lorenz

General Conference Director

Award Sponsors



2025 Speakers



*Not in specific order

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The other 20% is the cost of the raw material. If you move out to the entire supply chain, the picture flips the raw material cost down to 20%.

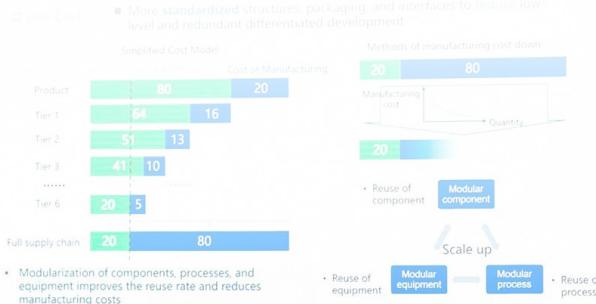
分析我们的成本时, 我们发现了一些有趣的东西, 看看我们的产品, 大约80%是炸弹的成本。

另外20%是制造的原因。但如果你把整个供应链放在一边, 情况就会发生变化。原材料只占

Keynote 1

Technological Evolution and Future Perspectives of Electric Vehicle
Liu Chang
Director of R&D Center
Suzhou Inovance Automotive Co., Ltd

Key Requirements of EV Power Electronics



- More standardized structures, packaging, and interfaces to reduce low-level and redundant differentiated development.

Methods of manufacturing cost down



- Reuse of component

Modular component

Scale up

- Reuse of equipment

Modular equipment

Modular process

Reuse of process

- Modularization of components, processes, and equipment improves the reuse rate and reduces manufacturing costs.

- Cost down of raw material by scale effect

“I was very pleased with the engagement after my keynote. We had significant figures and industrial leaders asking deep technical questions on topics ranging from AI power trends to our research into liquid metal. For a speaker, that direct, high-level interaction with an audience filled with industrial attendees is what makes this event so effective for bridging research and application.”

Prof Teng Long, Professor of Power Electronics, University of Cambridge

“As a semiconductor engineer focused on silicon carbide, I've found the techniques shared here quite insightful. For example, one talk on a new method to monitor chip temperature, a key challenge in our field, presented a very promising new approach. That's the real value; the point of these conventions isn't just to have results presented to you that you can copy and take home; it's about taking inspiration, and I'm all for that.”

Mr Peter Pang, Semiconductor Device Engineer, Alpha Power Solutions Limited

“The PCIM Asia Shanghai Conference plays a positive role in fostering exchange between academia and industry, serving as an international platform that brings together experts from China and abroad for high-level dialogue. The audience response was excellent; there was an enthusiastic atmosphere and a great deal of interaction during the opening ceremony and keynotes. I was especially pleased to see that the industrial application forum drew a larger crowd than expected.”

Prof Yongdong Li, Vice Dean, New Energy Vehicle Research Institute, Tsinghua University

04 Fringe Programs

Theme Forums



- WBG_GaN & SiC
- Power Devices
- Power Electronics
- Materials & Packaging
- E-mobility
- AI & Data Center

Summits

- Power Semiconductor Rising Star Summit
- Emerging Applications Summit

Display Zone

- Power Electronics for E-mobility Zone
- Industrial Chain Display Zone

Featured Zone

- Dialogue with Speakers Zone
- Industry – Academia - Research Collaboration Zone
- Job Fair

Tour

- PCIM Asia Shanghai Tour – E-mobility

PCIM Asia Shanghai 2025 Fringe Programs encompass Theme Forums, Summits, Display Zone, Featured Zone, and Tour, offers diverse perspectives on power electronic cutting-edge market trends.



Theme Forums

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7
Forum Topics

3,043
Forum Visits

71
Forum Presentations



Theme Forums focus on cutting-edge industry topics including Power Devices, WBG_GaN & SiC, Power Electronics, Materials & Packaging, E-mobility, and AI & Data Center. Experts from academia and leading industry share advanced technical solutions and provide insights into future industry trends.

Summits

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Emerging Applications Summit

- Focuses on the application of power electronics technology in two promising fields: eVTOL and Solid-State Circuit Breaker.
- The speakers come from Infineon Technologies, Wolong, Minth Group, Times Feipeng Technology, NORTHWESTERN POLYTECHNICAL UNIVERSITY, XI'AN JIAOTONG UNIVERSITY, KINGSI, and Shandong Taikai DC Technologies.

未来趋势应用峰会

Emerging Applications Summit

13:00-15:00 固态开关驱动下一代高频高可靠拓扑创新论坛
Solid-State Circuit Breaker Forum



上海新国际博览中心
Shanghai New International
Expo Centre (SNIEC)

2025—五
09/26
10:00-15:00



功率半导体新锐峰会

Power Semiconductor Rising Star Summit



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上海新国际博览中心
Shanghai New International
Exhibition & Convention Center

2025—五
09/26
10:00-15:00 | Hall N4
Booth No.
E50

Power Semiconductor Rising Star Summit

- 8 presentations cover IGBT and SiC devices from process platform to the latest advanced technologies.
- The speakers come from UESTC, UNT, Hisense Power Semiconductor, Huatai Electronics, Tankblue, GTA Semiconductor, Qingchun Semiconductor, and CETC Yangzhou Guoyang Electronics.

“I was very impressed with the Emerging Applications Summit. The agenda was highly focused, concentrating on the forward-looking field of low-altitude aircraft power technology, which is directly relevant to our work. The speakers shared deep and detailed insights on technology trends that I found incredibly valuable. This information will be a significant reference for our technology planning in the energy and automation fields, making this an insightful and valuable summit.”

Mr Ying Wang,
Senior Merge and Acquisition Manager,
Zhejiang Chint Electrics Co Ltd

“We attended the Power Semiconductor Rising Stars Summit to understand the latest advancements in chip design, energy efficiency and advanced packaging. The speakers offered practical insights into common technical challenges and their solutions, which is highly valuable for our technology roadmap and supply chain strategy. The summit was professionally organised, and it was an excellent opportunity to connect with emerging companies and witness the technological progress made by many local firms.”

Mr Weijian Pan, Huawei Technologies Co Ltd



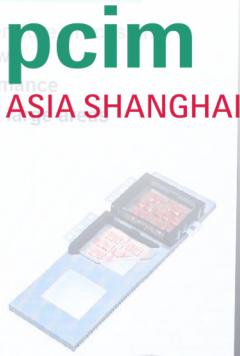
Fringe Programs

Acrylic-based conductive adhesive PE360P is a high viscosity, high solids content adhesive. It offers improved workability and printing capability on large areas.

PE360P offers a highly reliable and conductive solution for power module or substrate attach to a heatsink or baseplate.

Key Elements

- Low pressure and temperature (230 °C, 12MPa and below)
- Excellent printing performance
- Enhanced workability on large areas
- Stable rheology
- Void free
- No cleaning required
- Leadfree, Halogen zero



2025 Forum Sponsor



2025 Forum Speakers



*Not in specific order

Display Zone

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Display Enterprises



Industrial Chain Display Zone

Structured around the concept of "from materials to systems," it maps the entire power electronics supply chain. It will cover the progression from foundational wide-bandgap wafers and power devices to advanced packaging, modules, and the final system-level solutions used in applications like energy storage, ultra-fast charging, rail transportation and computing power supplies, illustrating the key trends that define the power electronics sector's role in global decarbonisation.

Power Electronics for E-mobility Zone

It demonstrate the extensive role of power electronics in electric and hybrid vehicles. Through a combination of interactive exhibits, live demonstrations, and equipment displays, the zone will showcase technologies for new energy vehicle applications, covering components from batteries, motors, and electronic controls to high-voltage power distribution units (PDU), onboard chargers (OBC), DC/DC converters and more..



Featured Zone & Tour

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PCIM Asia Shanghai provides a platform for the industry's colleges, scientific research institutions and student teams to exhibit and meet with the industry's leading corporates, in an effort to encourage both parties and create more possibilities together.

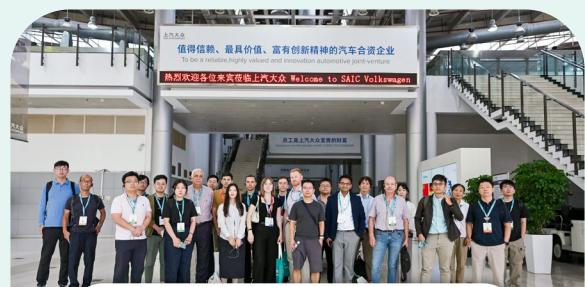
This format moves beyond one-way presentations to foster direct interactions between speakers and attendees across industry, academia, and research. It enables deeper Q&A, knowledge sharing, and the initiation of new collaborations.



Job Fair

This exclusive half-day tour for consultants from the advisory board, speakers and audiences, led by Professor Kang Jinsong of Tongji University, including a visit to the SAIC Volkswagen's MEB smart factory and Tongji University National Maglev Transportation Engineering R&D Centre, concluding with a closed-door roundtable discussion on smart manufacturing.

Nearly 30 enterprises posted around 40 recruitment information on Job Board, with the aim of building a communication bridge for enterprises, industry job seekers and university students, connecting academia and industry, promoting resource sharing, and jointly foster cooperation between enterprises and universities.



PCIM Asia Shanghai Tour – E-mobility

Contact Information

PCIM Asia Shenzhen 2026

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Wechat



LinkedIn



- » Power Electronics
- » Intelligent Motion
- » Renewable Energy
- » Energy Management

Date

26 – 28 August 2026

Venue

Shenzhen World Exhibition & Convention Center, China

Sequence

Annually

Organizer

Guangzhou Guangya Messe Frankfurt Co Ltd

Partner

Mesago Messe Frankfurt GmbH

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feodora.curtius@mesago.com

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26 – 28.8.2026

Shenzhen World Exhibition
and Convention Center, China
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